

High Power Infrared Emitting Diode, 850 nm, Surface Emitter Technology


AUTOMOTIVE
GRADE

RoHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

FEATURES

- Package type: surface-mount
- Package form: high power SMD with lens
- Dimensions (L x W x H in mm): 3.4 x 3.4 x 1.5
- Peak wavelength: $\lambda_p = 850$ nm
- AEC-Q102 qualified
- Angle of half intensity: $\phi = \pm 75^\circ$
- Designed for high drive currents: up to 1.5 A (DC) and up to 5 A (pulsed)
- Low thermal resistance: $5 \text{ K/W} < R_{thJP} < 9 \text{ K/W}$
- ESD: up to 5 kV (according to ANSI / ESDA / JEDEC® JS-001)
- Floor life: 168 h, MSL 3, according to J-STD-020E
- Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

LINKS TO ADDITIONAL RESOURCES



DESCRIPTION

As part of the [Astral](#) portfolio, the VSMA1085750X02 is an infrared, 850 nm emitting diode. It features a double stack emitter chip for highest radiant power. The 42 mil chip size allows 1.5 A DC operation and supports pulsed currents up to 5.0 A.

APPLICATIONS

- Driver and occupant monitoring
- Eye tracking
- Safety and security, CCTV

PRODUCT SUMMARY

COMPONENT	I_e (mW/sr) at $I_F = 1.0$ A	ϕ (°)	λ_p (nm)	$\lambda_{\text{centroid}}$ (nm)	t_r (ns)
VSMA1085750X02	360	± 75	850	845	13

Note

- Test conditions see table “Basic Characteristics”

ORDERING INFORMATION

ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
VSMA1085750X02	Tape and reel	MOQ: 600 pcs, 600 pcs/reel	High power with lens

Note

- MOQ: minimum order quantity



ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V_R	5	V
Minimum forward current		$I_{F, min.}$	100	mA
Forward current		I_F	1.5	A
Surge forward current	$t_p = 100\text{ }\mu\text{s}$	I_{FSM}	5	A
Power dissipation		P_V	5.33	W
Junction temperature		T_J	145	$^{\circ}\text{C}$
Ambient temperature range		T_{amb}	-40 to +125	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	-40 to +125	$^{\circ}\text{C}$
Soldering temperature	According to Fig. 11, J-STD-020E	T_{sd}	260	$^{\circ}\text{C}$
Thermal resistance junction to solder point real ⁽¹⁾	JESD 51	$R_{thJSP,real}$	5 to 9	K/W
Thermal resistance junction to ambient real	JESD 51	$R_{thJA,real}$	80	K/W
ESD sensitivity	According to ANSI / ESDA / JEDEC JS-001	V_{ESD}	5	kV

Note

- ⁽¹⁾ Thermal resistance junction to solder point real has been measured with the part mounted on an ideal heatsink and the optical output power has been deducted from the total electrical power dissipation

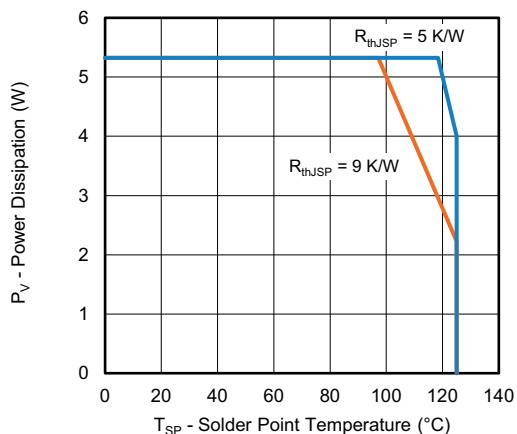


Fig. 1 - Power Dissipation Limit vs. Solder Point Temperature

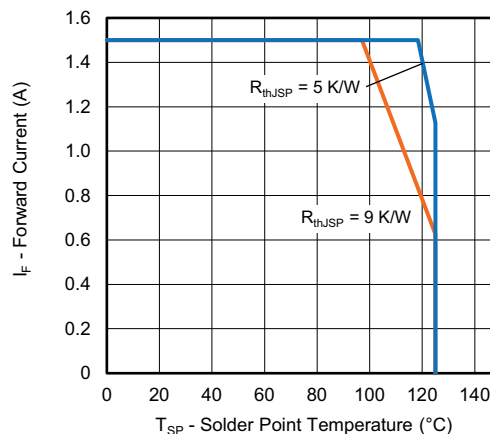


Fig. 2 - Forward Current Limit vs. Solder Point Temperature

BASIC CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 0.35\text{ A}$, $t_p = 10\text{ ms}$	V_F	2.7	2.8	3.1	V
	$I_F = 1\text{ A}$, $t_p = 100\text{ }\mu\text{s}$	V_F	2.8	3.0	3.3	V
	$I_F = 1.5\text{ A}$, $t_p = 100\text{ }\mu\text{s}$	V_F	2.9	3.2	3.55	V
	$I_F = 5\text{ A}$, $t_p = 100\text{ }\mu\text{s}$	V_F	3.2	3.9	4.4	V
Temperature coefficient of V_F	$I_F = 1\text{ A}$, $t_p = 100\text{ }\mu\text{s}$		-	-2	-	mV/K
Reverse current ⁽¹⁾		I_R	Not designed for reverse operation			μA
Radiant intensity ⁽²⁾	$I_F = 0.35\text{ A}$, $t_p = 10\text{ ms}$	I_e	90	130	170	mW/sr
	$I_F = 1\text{ A}$, $t_p = 100\text{ }\mu\text{s}$	I_e	250	360	450	mW/sr
	$I_F = 1.5\text{ A}$, $t_p = 100\text{ }\mu\text{s}$	I_e	370	535	670	mW/sr
	$I_F = 5\text{ A}$, $t_p = 100\text{ }\mu\text{s}$	I_e	1130	1600	2050	mW/sr
Radiant power	$I_F = 1\text{ A}$, $t_p = 100\text{ }\mu\text{s}$	ϕ_e	-	1450	-	mW
	$I_F = 1.5\text{ A}$, $t_p = 100\text{ }\mu\text{s}$	ϕ_e	-	2125	-	mW
Temperature coefficient of ϕ	$I_F = 1\text{ A}$, $t_p = 100\text{ }\mu\text{s}$	TK_{ϕ}	-	-0.15	-	%/K
Angle of half intensity		ϕ	-	± 75	-	$^{\circ}$
Peak wavelength	$I_F = 1\text{ A}$, $t_p = 100\text{ }\mu\text{s}$	λ_p	-	850	-	nm
Centroid wavelength	$I_F = 1\text{ A}$, $t_p = 100\text{ }\mu\text{s}$	$\lambda_{\text{centroid}}$	-	845	-	nm
Spectral bandwidth	$I_F = 1\text{ A}$, $t_p = 100\text{ }\mu\text{s}$	$\Delta\lambda$	-	30	-	nm
Temperature coefficient of λ_p	$I_F = 100\text{ mA}$, $t_p = 20\text{ ms}$	TK_{λ_p}	-	0.25	-	nm/K
Rise time	$I_F = 1\text{ A}$, $R_L = 50\text{ }\Omega$	t_r	-	13	-	ns
Fall time	$I_F = 1\text{ A}$, $R_L = 50\text{ }\Omega$	t_f	-	16	-	ns

Notes

- (1) This infrared LED is designed to be operated within the specified forward current range. Continuous reverse operation must be avoided because it may damage the infrared LED.
- (2) The radiant intensity values have been measured with a tolerance of $\pm 11\%$

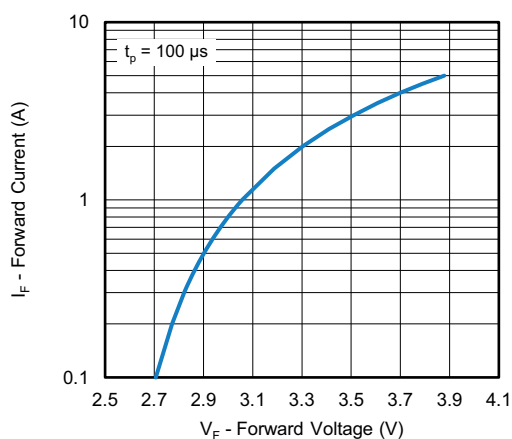
BASIC CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 3 - Forward Current vs. Forward Voltage

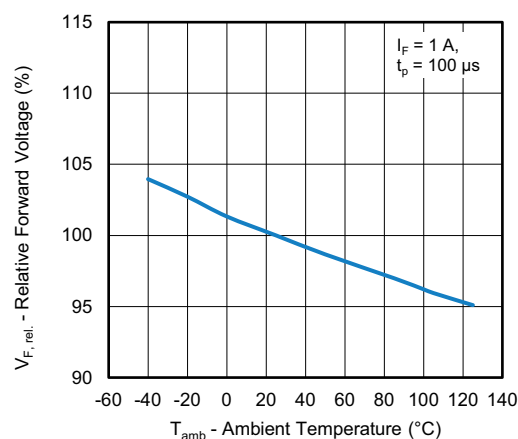


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

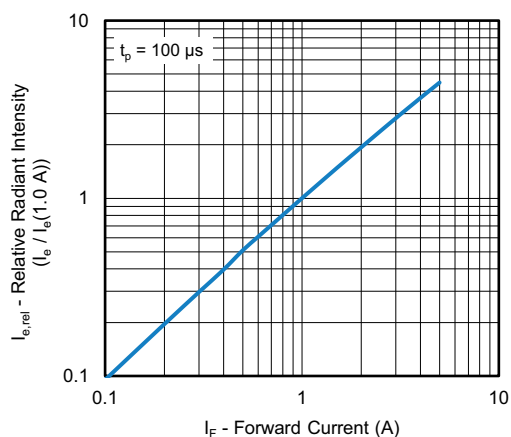


Fig. 5 - Relative Radiant Intensity vs. Forward Current

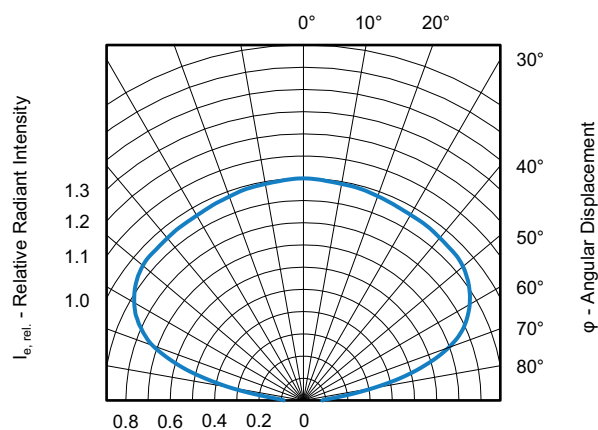


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

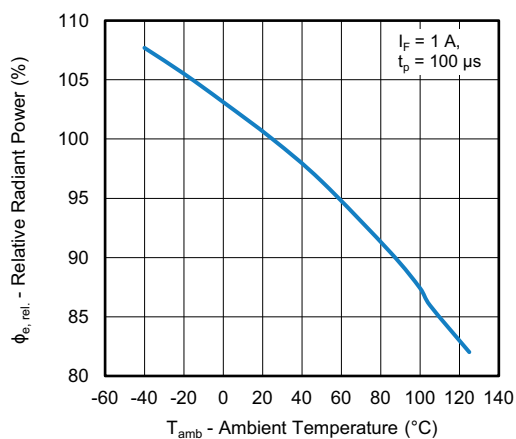


Fig. 6 - Relative Radiant Power vs. Ambient Temperature

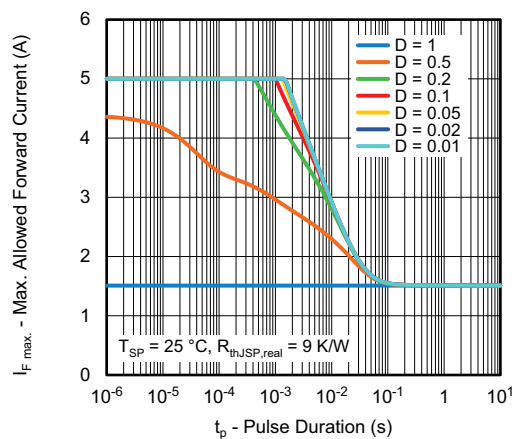


Fig. 9 - Max. Allowed Forward Current vs. Pulse Duration

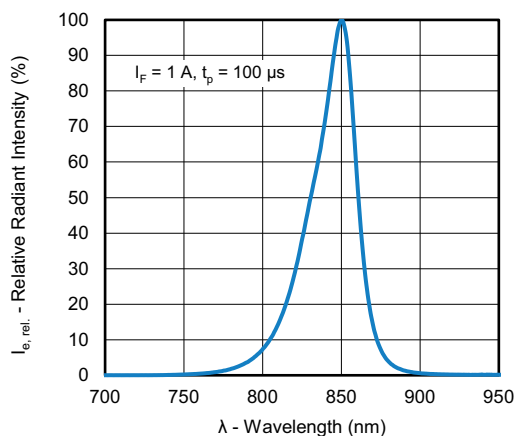


Fig. 7 - Relative Radiant Intensity vs. Wavelength

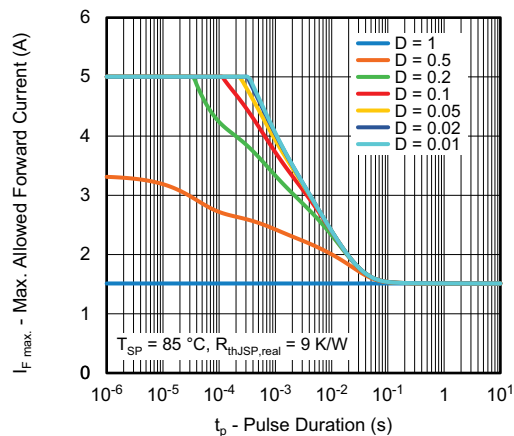
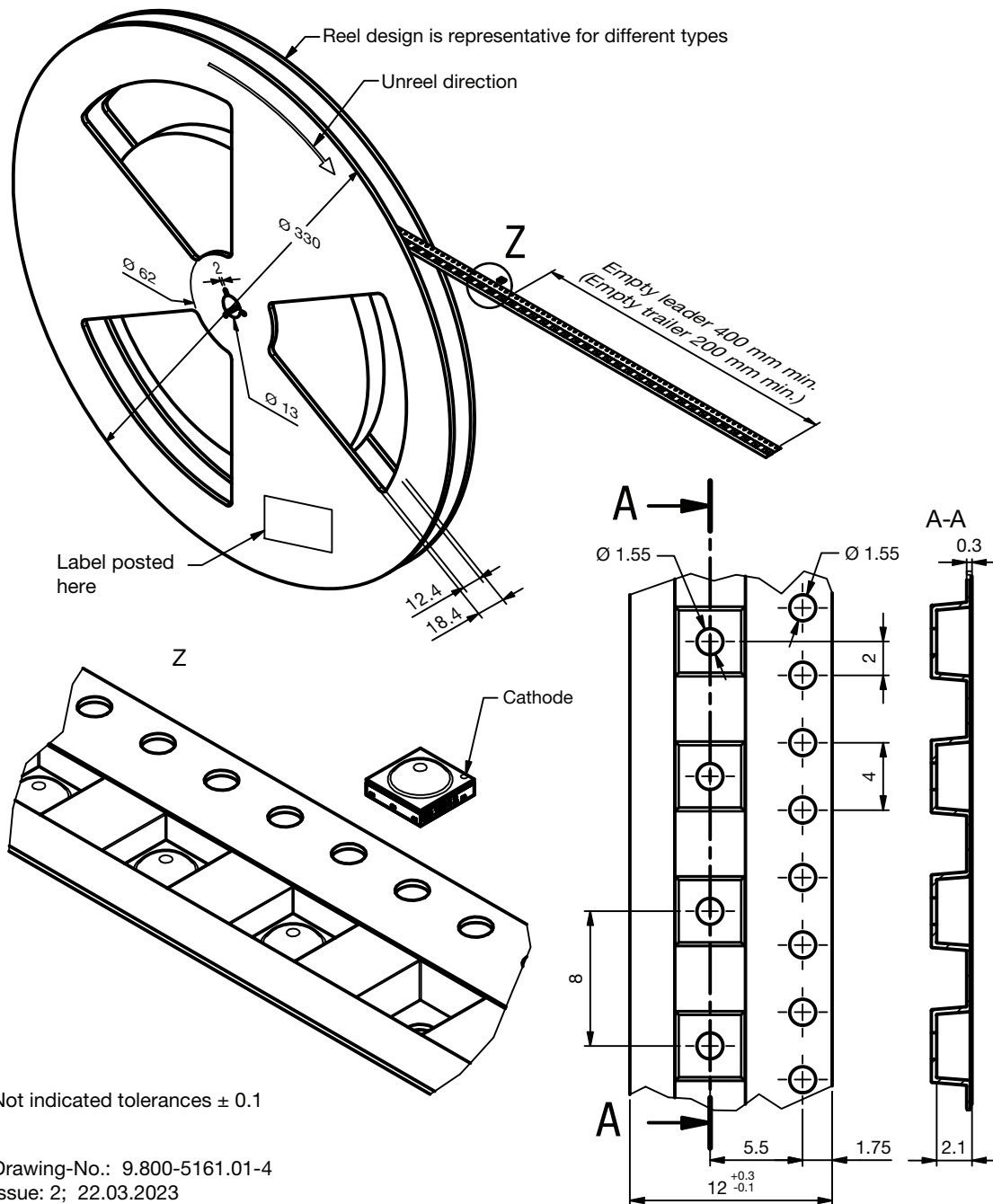
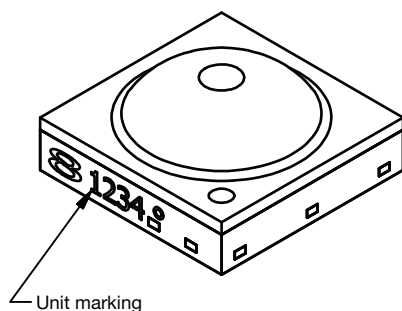
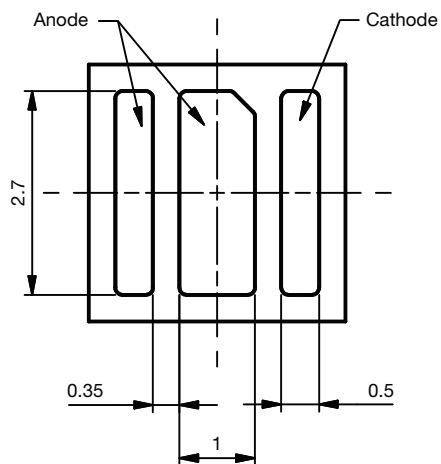
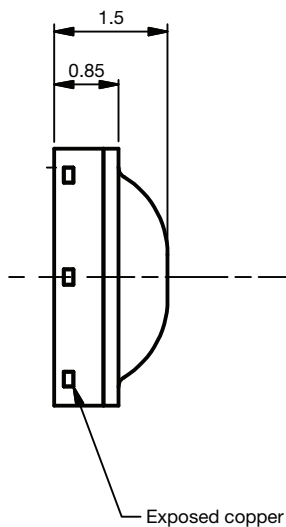
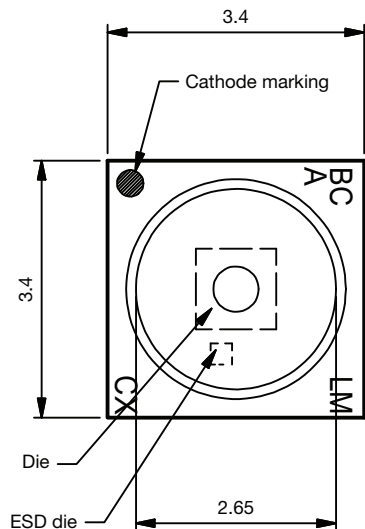
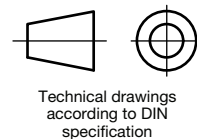


Fig. 10 - Max. Allowed Forward Current vs. Pulse Duration

TAPING DIMENSIONS in millimeters

Notes

- Empty component pockets sealed with top cover tape
- 7 inch reel - 600 pieces per reel
- The maximum number of consecutive missing lamps is two
- In accordance with ANSI / EIA 481-1-A-1994 specifications

PACKAGE DIMENSIONS in millimeters

Not indicated tolerances ± 0.1

Drawing-No.: 6.550-5384.01-4
Issue: 1; 23.02.2023

Notes

- Tolerance is ± 0.10 mm (0.004") unless otherwise noted
- Specifications are subject to change without notice



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